

Electrically Conductive Adhesive Transfer Tape Solutions

Z-Axis Conductive Particle Based

XYZ-Axis Conductive Particle Based

XYZ-Axis Conductive D/C Foil Based

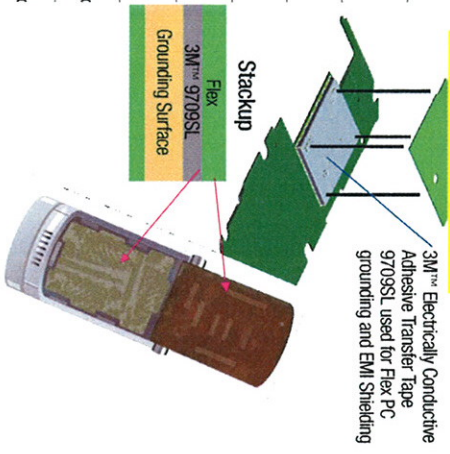
XYZ-Axis Conductive Non-woven Scrim Based

Product	Pictorial Design	Thickness (µm)	Conductivity (Based on 3M Test Method)	Z or XYZ	Conductive Filler Type	Adhesive Type	Features, Advantages, and Benefits
9703		50	Z	Silver	Low Outgassing Acrylic ECATT	Z-Axis, Low Outgassing	
9705		50	Z	Silver	Standard Acrylic ECATT	Z-Axis, Standard outgassing version of 9703.	
9706		50	Z	Silver	High Adhesion Acrylic ECATT	High Adhesion version of the 9705	
9707		50	XYZ	Silver	High Adhesion Acrylic ECATT	High Adhesion, "Bond Line Gap/Silt" EMI Shielding for High Frequency, Low contact R to SS	
9709		50	XYZ	Silver	Standard Acrylic ECATT	Standard Adhesion, "Bond Line Gap/Silt" EMI Shielding for High Frequency	
9709S		50	XYZ	Silver	Standard Acrylic ECATT	Standard Adhesion, "Bond Line Gap/Silt" EMI Shielding for High Frequency, Low contact R to SS	
9709SL		50	XYZ	Silver	Standard Acrylic ECATT	Premium low liner release version of 9709S	
7810		150	XYZ	Nickel			
7805		150	XYZ	Silver			
7850		150	XYZ	Carbon			
7772		66	XYZ	Nicke & Alum DC			
9712		125	XYZ	Carbon			
9713		89	XYZ	Nickel/C			
9719		100	XYZ	Nickel/C			
9720		35	XYZ	Nickel/Cu			
9723		60	XYZ	Nickel/Cu			
9725		50	XYZ	Nickel/Cu			
9732		100	XYZ	Nickel/Cu			
9760		50	XYZ	Nickel/Cu Dc			
9780		200	XYZ	Nickel/Cu Dc			



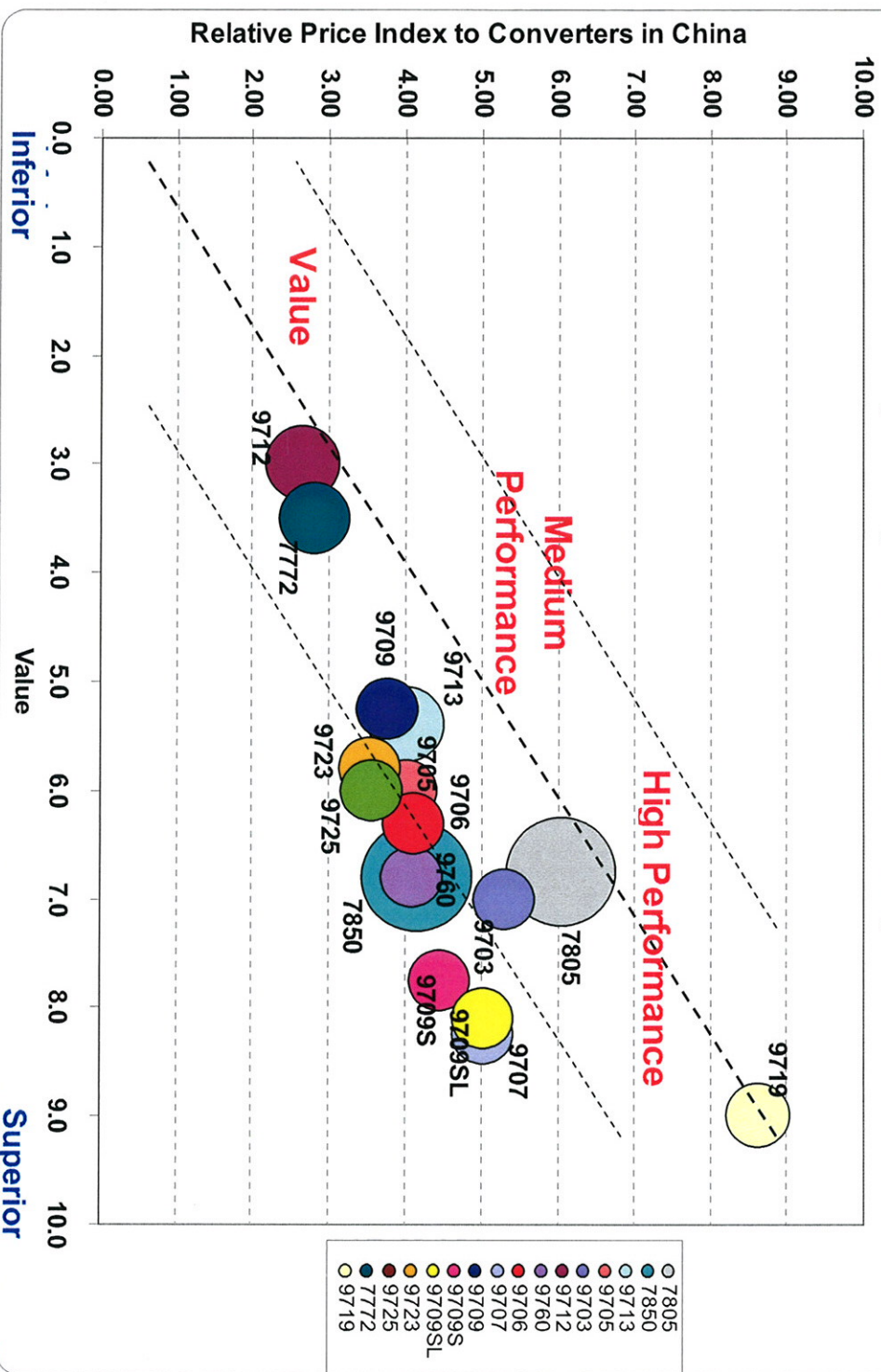
WHERE USED ??

- 3M™ EMI Shield Attachment Conductive Adhesives**
- Grounding and attach EMI foil or conductive fabric
 - Enhanced grounding
 - Inherent bond line EMI shielding



3M EMI / EMC Solutions

3M Go-To Electrically Conductive Adhesive Transfer Tape (ECATT) Price Index/Value Map



Bubble size = tape thickness

